



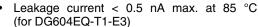
1.0 pC Charge Injection, 100 pA Leakage, 4-Channel Multiplexer

DESCRIPTION

The DG604 is an analog 4-channel CMOS, multiplexer, designed to operate from a + 2.7 V to + 12 V single supply or from \pm 2.7 V to \pm 5 V, dual supplies. The DG604 is fully specified at +3 V, +5 V and $\pm 5 \text{ V}$. All control logic inputs have guaranteed 2 V logic high limits when operating from + 5 V or ± 5 V supplies and 1.4 V when operating from a 3 V supply. The DG604 switches conduct equally well in both directions and offer rail to rail analog signal handling. < 1 pC low charge injection, coupled with very low switch capacitance and leakage current makes this product ideal for use in precision instrumentation applications. Operating temperature range is specified from - 40 °C to + 125 °C. The DG604 is available in 14 lead TSSOP and the space saving 1.8 mm x 2.6 mm miniQFN package.

FEATURES

- Halogen-free according to IEC 61249-2-21 Definition
- Ultra low charge injection (± 1 pC, typ. over the full analog signal range)



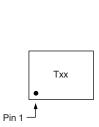


- Low switch capacitance (C_{soff}, 3 pF typ.)
- Low $R_{DS(on)}$ 115 Ω max.
- Fully specified with single supply operation at 3 V, 5 V and dual supplies at ± 5 V
- Low voltage, 2.5 V CMOS/TTL compatible
- 400 MHz. 3 dB bandwidth
- Excellent isolation crosstalk performance (typ. > -60 dB at 10 MHz)
- Fully specified from 40 °C to 85 °C and 40 °C to + 125 °C
- 14 pin TSSOP and 16 pin miniQFN package (1.8 mm x 2.6 mm)
- Compliant to RoHS Directive 2002/95/EC

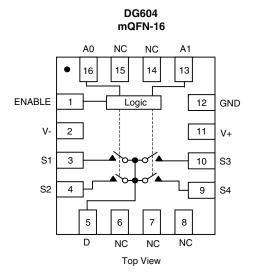
APPLICATIONS

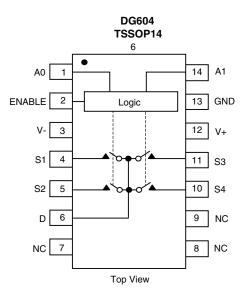
- High-end data acquisition
- Medical instruments
- Precision instruments
- High speed communications applications
- Automated test equipment
- Sample and hold applications

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



Device Marking: Txx for DG604 xx = Date/Lot Traceability Code







TRUTH TABLE			
Enable	Select	ed Input	On Switches
Input	A1	A0	DG604
L	X	Х	All Switches Open
Н	L	L	D to S1
Н	L	Н	D to S2
Н	Н	L	D to S3
Н	Н	Н	D to S4

ORDERING INFORMA	ATION	
Temp. Range	Package	Part Number
40.00 1. 405.008	14 pin TSSOP	DG604EQ-T1-E3
- 40 °C to 125 °C ^a	16 pin miniQFN	DG604EN-T1-E4

Notes:

a. - 40 $^{\circ}\text{C}$ to 85 $^{\circ}\text{C}$ datasheet limits apply.

ABSOLUTE MAXIMUM RAT	FINGS T _A = 25 °C, unless ot	herwise noted	
Parameter		Limit	Unit
V+ to V-		14	
GND to V-		7	\Box v
Digital Inputs ^a , V _S , V _D		(V-) - 0.3 to (V+) + 0.3 or 30 mA, whichever occurs first	
Continuous Current (Any Terminal)		30	A
Peak Current, S or D (Pulsed 1 ms, 10 %	6 Duty Cycle)	100	mA
Storage Temperature		- 65 to 150	°C
Power Dissipation (Package) ^b	14 pin TSSOP ^c	450	m\\\
Power Dissipation (Package)	16 pin miniQFN ^{d, e}	525	mW
Thermal Desistance (Deskage)b	14 pin TSSOP	178	C/W
Thermal Resistance (Package) ^b	16 pin miniQFN	152	

Notes:

- a. Signals on SX, DX, or INX exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC board.
- c. Derate 5.6 mW/°C above 70 °C.
- d. Derate 6.6 mW/°C above 70 °C.
- e. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

SPECIFICATIONS	FOR DU	JAL SUPPLIES							
		Test Conditions			- 40 °C t	o 125 °C	- 40 °C	to 85 °C	
Parameter	Symbol	Unless Otherwise Specified V+=5 V, V-=-5 V $V_{\text{IN A0, A1 and ENABLE}}=2 \text{ V, 0.8 V}^{\text{a}}$	Temp.b	Typ. ^c	Min. ^d	Max. ^d	Min. ^d	Max. ^d	Unit
Analog Switch									
Analog Signal Range ^e	V _{ANALOG}		Full		- 5	5	- 5	5	٧
On-Resistance	R _{DS(on)}	I _S = 1 mA, V _D = -3 V, 0 V, +3 V	Room Full	70		115 160		115 140	
On-Resistance Match	ΔR _{ON}	$I_S = 1 \text{ mA}, V_D = \pm 3 \text{ V}$	Room Full	1		5 6.5		5 6.5	Ω
On-Resistance Flatness	R _{FLATNESS}	I _S = 1 mA, V _D = -3 V, 0 V, +3 V	Room Full	10		20 33		20 22	



SPECIFICATIONS	FOR D	JAL SUPPLIES							
		Test Conditions Unless Otherwise Specified			- 40 °C t	o 125 °C	- 40 °C	to 85 °C	
		V+ = 5 V, V- = - 5 V							
Parameter	Symbol	$V_{IN A0, A1 and ENABLE} = 2 V, 0.8 V^a$	Temp.b	Typ. ^c	Min. ^d	Max. ^d	Min. ^d	Max. ^d	Unit
Analog Switch		T	D	0.04	0.4	0.4	0.4		l
Switch Off	I _{S(off)}	V+ = 5.5 V, V- = - 5.5 V	Room Full	± 0.01	- 0.1 - 18	0.1 18	- 0.1 - 0.5	0.1 0.5	
Leakage Current (for 14 pin TSSOP)	I _{D(off)}	$V_D = \pm 4.5 \text{ V}, V_S = \pm 4.5 \text{ V}$	Room Full	± 0.01	- 0.1 - 18	0.1 18	- 0.1 - 0.5	0.1 0.5	
Channel On Leakage Current (for 14 pin TSSOP)	I _{D(on)}	V+ = 5.5 V, V- = -5.5 V, $V_S = V_D = \pm 4.5 \text{ V}$	Room Full	± 0.01	- 0.1 - 18	0.1 18	- 0.1 - 0.5	0.1 0.5	nA
Switch Off Leakage Current	I _{S(off)}	V+ = 5.5 V, V- = - 5.5 V	Room Full	± 0.01	- 1 - 18	1 18	- 1 - 2	1 2	IIA
(for 16 pin miniQFN)	I _{D(off)}	$V_D = \pm 4.5 \text{ V}, V_S = \mp 4.5 \text{ V}$	Room Full	± 0.01	- 1 - 18	1 18	- 1 - 2	1 2	
Channel On Leakage Current (for 16 pin miniQFN)	$I_{D(on)}$	V+ = 5.5 V, V- = -5.5 V, $V_S = V_D = \pm 4.5 \text{ V}$	Room Full	± 0.01	- 1 - 18	1 18	- 1 - 2	1 2	
Digital Control									
Input Current, V _{IN} Low	I _{IL}	V _{IN A0, A1 and ENABLE} Under Test = 0.8 V	Full	0.005	- 0.1	0.1	- 0.1	0.1	
Input Current, V _{IN} High	I _{IH}	V _{IN A0, A1 and ENABLE} Under Test = 2 V	Full	0.005	- 0.1	0.1	- 0.1	0.1	μΑ
Input Capacitance ^e	C _{IN}	f = 1 MHz	Room	3.4					pF
Dynamic Characteristics								•	
Transition Time	t _{TRANS}	$V_{S(CLOSE)} = 3 \text{ V}, V_{S(OPEN)} = 0 \text{ V},$ $R_L = 300 \Omega, C_L = 35 \text{ pF}$	Room Full	20		70 105		70 80	
Turn-On Time	t _{ON}	$R_L = 300 \Omega$, $C_L = 35 pF$	Room Full	16		60 90		60 65	ns
Turn-Off Time	t _{OFF}	$V_S = \pm 3 V$	Room Full	15		52 76		52 56	115
Break-Before-Make Time Delay	t_D	$V_S = 3 V$ $R_L = 300 \Omega, C_L = 35 pF$	Room Full	15	10		10		
Charge Injection ^e	Q	$V_g = 0 \text{ V}, R_g = 0 \Omega, C_L = 1 \text{ nF}$	Room	0.7					рС
Off Isolation ^e	OIRR	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$	Room	- 72					dB
Bandwidth ^e	BW	$R_L = 50 \Omega$	Room	400					MHz
Channel-to-Channel Crosstalk ^e	X _{TALK}	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$	Room	- 81					dB
Source Off Capacitance ^e	C _{S(off)}		Room	2.7					
Drain Off Capacitance ^e	C _{D(off)}	f = 1 MHz	Room	7.3					pF
Channel On Capacitance ^e	C _{D(on)}		Room	13.8					
Total Harmonic Distortion ^e	THD	Signal = 1 V_{RMS} , 20 Hz to 20 kHz, $R_L = 600 \Omega$	Room	0.01					%
Power Supplies		1			L			I	l
Power Supply Current	l+		Room Full	0.001		0.5 1		0.5 1	
Negative Supply Current	I-	V _{IN} = 0 V, or V+	Room Full	- 0.001	- 0.5 - 1		- 0.5 - 1		μΑ
Ground Current	I _{GND}		Room Full	- 0.001	- 0.5 - 1		- 0.5 - 1		



		Test Conditions			- 40 °C t	o 125 °C	- 40 °C	to 85 °C	
		Unless Otherwise Specified V+ = 5 V, V- = 0 V							
Parameter	Symbol	V _{IN A0, A1 and ENABLE} = 2 V, 0.8 V ^a	Temp.b	Typ. ^c	Min. ^d	Max. ^d	Min. ^d	Max. ^d	Uni
Analog Switch			ı		ı	1	Т		
Analog Signal Range ^e	V_{ANALOG}		Full			5		5	V
On-Resistance	R _{DS(on)}	$I_S = 1 \text{ mA}, V_D = +3.5 \text{ V}$	Room Full	120		170 250		170 200	Ω
On-Resistance Match	ΔR_{ON}	$I_S = 1 \text{ mA}, V_D = +3.5 \text{ V}$	Room Full	3		5 12		5 10	32
Switch Off Leakage Current	I _{S(off)}	V+ = 5.5 V, V- = 0 V	Room Full	± 0.01	- 0.1 - 18	0.1 18	- 0.1 - 0.5	0.1 0.5	
(for 14 pin TSSOP)	I _{D(off)}	$V_D = 1 \text{ V}/4.5 \text{ V}, V_S = 4.5 \text{ V}/1 \text{ V}$	Room Full	± 0.01	- 0.1 - 18	0.1 18	- 0.1 - 0.5	0.1 0.5	
Channel On Leakage Current (for 14 pin TSSOP)	I _{D(on)}	V+ = 5.5 V, V- = 0 V $V_S = V_D = 1 \text{ V}/4.5 \text{ V}$	Room Full	± 0.01	- 0.1 - 18	0.1 18	- 0.1 - 0.5	0.1 0.5	
Switch Off Leakage Current	I _{S(off)}	V+ = 5.5 V, V- = - 5.5 V	Room Full	± 0.01	- 1 - 18	1 18	- 1 - 2	1 2	nA
(for 16 pin miniQFN)	I _{D(off)}	$V_D = 1 \text{ V}/4.5 \text{ V}, V_S = 4.5 \text{ V}/1 \text{ V}$	Room Full	± 0.01	- 1 - 18	1 18	- 1 - 2	1 2	
Channel On Leakage Current (for 16 pin miniQFN)	$I_{D(on)}$	V+ = 5.5 V, V- = 0 V, $V_S = V_D = 1 \text{ V}/4.5 \text{ V}$	Room Full	± 0.01	- 1 - 18	1 18	- 1 - 2	1 2	
Digital Control						•			
Input Current, V _{IN} Low	l _L	V _{IN A0, A1 and ENABLE} Under Test = 0.8 V	Full	0.005	- 0.1	0.1	- 0.1	0.1	
Input Current, V _{IN} High	I _H	V _{IN A0, A1 and ENABLE} Under Test = 2 V	Full	0.005	- 0.1	0.1	- 0.1	0.1	μΑ
Input Capacitance	C _{IN}	f = 1 MHz	Room	4.3					pF
Dynamic Characteristics									
Transition Time	t _{TRANS}		Room Full	36		75 120		75 95	
Enable Turn-On Time	t _{ON(EN)}	$V_{S(CLOSE)} = 3 \text{ V}, V_{S(OPEN)} = 0 \text{ V},$ $R_L = 300 \Omega, C_L = 35 \text{ pF}$	Room Full	30		70 102		70 80	
Enable Turn-Off Time	t _{OFF(EN)}		Room Full	17		47 88		47 63	ns
Break-Before-Make-Time	t _{BMM}		Room Full	23	5		5		
Charge Injection	Q	$C_L = 1 \text{ nF, } R_{GEN} = 0 \Omega, V_{GEN} = 0 V$	Full	0.15					рС
Off-Isolation ^e	OIRR	$f = 10 \text{ MHz}, R_L = 50 \Omega, C_L = 5 \text{ pF}$	Room	- 58					dB
Crosstalk ^e	X _{TALK}	1 = 10 Νπ12, Τιξ = 30 32, Θξ = 3 βι	Room	- 81					ub
Bandwidth ^e	BW	$R_L = 50 \Omega$	Room	330					MHz
Total Harmonic Distortion	THD	Signal = 1 V_{RMS} , 20 Hz to 20 kHz, $R_L = 600 \Omega$	Room	0.009					%
Source Off Capacitance ^e	C _{S(off)}			3.1					
Drain Off Capacitance ^e	C _{D(off)}	f = 1 MHz	Room	11.6					pF
Channel On Capacitance ^e	C _{D(on)}			16.2					1
Power Supplies			L		L		L		
Power Supply Current	l+		Room Full	0.001		0.5 1		0.5 1	
Negative Supply Current	I-	V _{IN} = 0 V, or V+	Room Full	- 0.001	- 0.5 - 1		- 0.5 - 1		μΑ
Ground Current	I _{GND}		Room	- 0.001	- 0.5		- 0.5		

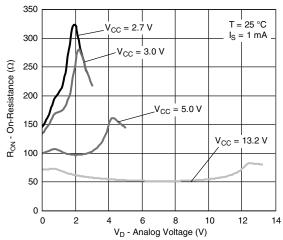




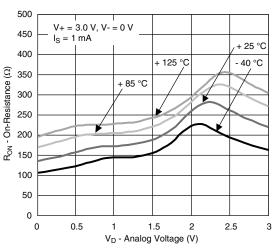
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	3 245 290 11 6 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 1 1 2 2 1 1 2	- 0.1 - 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.1 - 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.1 - 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.1 - 0.5 - 0.1 - 0.5	- 0.1 - 0.5 - 0.1 - 0.5	- CC	3 245 325 6 13 0.1 18	- 0.1	200 5 ± 0.01	Full Room Full Room Full Room	V+ = 3 V, V- = 0 V V _{IN A0, A1 and ENABLE} = 1.4 V, 0.6 V ^a		Parameter
Parameter Symbol V _{IN AO, A1 and ENABLE} = 1.4 V, 0.6 V ⁸ Temp. ^b Typ. ^c Min. ^d Max. ^d Min. Analog Switch	3 245 290 11 6 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 1 1 2 2 1 1 2	- 0.1 - 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.1 - 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.1 - 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.1 - 0.5 - 0.1 - 0.5	- 0.1 - 0.5 - 0.1 - 0.5	- CC	3 245 325 6 13 0.1 18	- 0.1	200 5 ± 0.01	Full Room Full Room Full Room	V _{IN A0, A1 and ENABLE} = 1.4 V, 0.6 V ^a		Parameter
Analog Switch Analog Signal Range Vanalog Is = 1 mA, VD = + 1.5 V Room Full 3 3 2245 3225 3	245 290 11 6 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 1 2 2 2 1 1 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.5 - 0.1 - 0.5 - 0.1	- 0.5 - 0.1 - 0.5	- C	245 325 6 13 0.1 18	- 18	200 5 ± 0.01	Room Full Room Full Room		.,	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	245 290 11 6 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 1 2 2 2 1 1 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.5 - 0.1 - 0.5 - 0.1	- 0.5 - 0.1 - 0.5	- C	245 325 6 13 0.1 18	- 18	5 ± 0.01	Room Full Room Full Room	I _S = 1 mA, V _D = + 1.5 V		Analog Switch
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	290 11 6 .1 .5 .0.5 .1 .5 .0.5 .1 .5 .0.5 .1 .1 .5 .1 .5 .1 .1 .5 .1 .1 .5 .1 .1 .5 .1 .1 .1 .1 .1 .2 .2 .1 .1 .1 .1 .1 .2 .2 .1 .1 .1 .1 .2 .2 .1 .1 .1 .1 .2 .2 .1 .1 .1 .1 .2 .2 .1 .1 .1 .2 .2 .1 .1 .1 .2 .2 .1 .1 .1 .1	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.5 - 0.1 - 0.5 - 0.1	- 0.5 - 0.1 - 0.5	- C	325 6 13 0.1 18 0.1	- 18	5 ± 0.01	Full Room Full Room	I _S = 1 mA. V _D = + 1.5 V	V _{ANALOG}	Analog Signal Range ^e
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	6 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 1 2 2 1 1 2 2 1 1 1	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.5 - 0.1 - 0.5 - 0.1	- 0.5 - 0.1 - 0.5	- C	0.1 18 0.1	- 18	± 0.01	Full Room	3 , 5	R _{DS(ON)}	On-Resistance
	.5 0.5 .1 0.1 .5 0.5 .1 0.1 .5 0.5 .1 1 0.1 .5 0.5 .1 1 1 .2 2 .1 1 1	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 0.1 - 0.5	- 0.5 - 0.1 - 0.5 - 0.1	- 0.5 - 0.1 - 0.5	- C	18 0.1	- 18			I _S = 1 mA, V _D = + 1.5 V	ΔR _{ON}	On-Resistance Match
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$.5 0.5 .1 0.1 .5 0.5 1 1 2 2 1 1 1 1	- 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 1 - 2 - 1 - 2	- 0.5 - 0.1 - 0.5 - 1	- 0.5 - 0.1	- 0.5	- C		0.1		Full	- , -	I _{S(off)}	
	.5 0.5 1 1 2 2 1 1 2 2	- 0.5 - 1 - 2 - 1 - 2	- 0.5 - 1 - 2 - 1 - 2	- 0.5 - 1		- 0 1		10		± 0.01			I _{D(off)}	
	2 2 1 1 2 2 1 1	- 2 - 1 - 2 - 1	- 2 - 1 - 2		- 0.5					± 0.01			I _{D(on)}	
(for 16 pin miniQFN) $I_{D(off)}$ $V_D = I \ V/3 \ V, \ V_S = 3 \ V/1 \ V$ Room Full ± 0.01 -1 1 1 -18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 -2 18 18 18 -2 18 18 -2 18 18 -2 18 18 18 -2 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 -2 18 18 18 18 -2 18 18 18 18 -2 18 18 18 18 -2 18 18 18 18 -2 18 18 18 18 18 18 18 18 18 18 18 18 18	2 2	- 2 - 1	- 2	- 2						± 0.01		,	I _{S(off)}	
Leakage Current (for 16 pin miniQFN) $I_{D(on)}$ $V_{+} = 3.3 \text{ V}, V_{-} = 0 \text{ V}$ Room Full ± 0.01 -1 1 -2 Digital Control Input Current, V_{IN} Low I_{L} V_{IN} A0, A1 and ENABLE Under Test = 0.6 V Full 0.005 -1 1 -3 Input Current, V_{IN} High I_{H} V_{IN} A0, A1 and ENABLE Under Test = 1.4 V Full 0.005 -1 1 -3 Input Capacitance C_{IN} I_{IN} <td< td=""><td></td><td></td><td>- 1</td><td></td><td></td><td>I</td><td></td><td></td><td></td><td>± 0.01</td><td></td><td>$V_D = 1 \text{ V/3 V}, V_S = 3 \text{ V/1 V}$</td><td>I_{D(off)}</td><td></td></td<>			- 1			I				± 0.01		$V_D = 1 \text{ V/3 V}, V_S = 3 \text{ V/1 V}$	I _{D(off)}	
Input Current, V_{IN} Low I_L V_{IN} A0, A1 and ENABLE Under Test = 0.6 V V_{IN} A0, A1 and ENABLE Under Test = 1.4 V V_{IN} A0, A1 and ENABLE Under Test = 1.4 V V_{IN} A0, A1 and ENABLE Under Test = 1.4 V V_{IN} A0, A1 and ENABLE Under Test = 1.4 V V_{IN} A0, A1 and ENABLE Under Test = 1.4 V V_{IN} A0, A1 and ENABLE Under Test = 1.4 V V_{IN}			- 2							± 0.01			I _{D(on)}	Leakage Current
Input Current, V_{IN} High I_{H} $V_{IN A0, A1 \text{ and ENABLE}}$ $V_{IN A0, A1 and ENA$														Digital Control
Input Capacitance C_{IN} $f = 1 \text{MHz}$ $Room$ 4.3 Dynamic Characteristics Transition Time t_{TRANS} Enable Turn-On Time $t_{ON(EN)}$ $t_{ON(EN)}$ The second of the second $t_{ON(EN)}$	1 1	- 1	- 1	- 1	- 1	- 1	-	1	- 1	0.005	Full		ΙL	Input Current, V _{IN} Low
	1 1	- 1	- 1	- 1	- 1	- 1	-	1	- 1	0.005	Full		I _H	Input Current, V _{IN} High
Transition Time t_{TRANS} Enable Turn-On Time $t_{ON(EN)}$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$ $E_{L} = 300 \ \Omega, \ C_{L} = 35 \ pF$										4.3	Room	f = 1 MHz	C _{IN}	Input Capacitance
Transition Time t_{TRANS} Enable Turn-On Time $t_{ON(EN)}$ $V_{S(CLOSE)} = 3 \text{ V, } V_{S(OPEN)} = 0 \text{ V,}$ $R_L = 300 \Omega, C_L = 35 \text{ pF}$ Full 190 $Room 77$ Full 108 $Room 35$ $Room 35$ $Room 35$											<u> </u>		L	Dynamic Characteristics
Enable Turn-Off Time $t_{ON(EN)}$ $R_L = 300 \Omega$, $C_L = 35 \text{ pF}$ Full 161 Enable Turn-Off Time $t_{OFF(EN)}$	130 160									95			t _{TRANS}	Transition Time
Enania Ilirn-()TT Ilma I locc/cn/, I	108 131									77			t _{ON(EN)}	Enable Turn-On Time
	76 88									35			t _{OFF(EN)}	Enable Turn-Off Time
		5	5	5	5	5	Ę		5		Full		t _{BMM}	Break-Before-Make-Time
Charge Injection Q $C_L = 1 \text{ nF}, R_{GEN} = 0 \Omega, V_{GEN} = 0 V$ Full 0.1										0.1	Full	$C_L = 1 \text{ nF, } R_{GEN} = 0 \Omega, V_{GEN} = 0 V$	Q	
Off-Isolation ^e OIRR $f = 10 \text{ MHz}, R_L = 50 \Omega, C_L = 5 \text{ pF}$										- 58	Room	$f = 10 \text{ MHz}$. $R_1 = 50 \Omega$. $C_1 = 5 \text{ pF}$		
Crosstalk ^e X _{TALK} Hoom - 90										- 90	Room		X _{TALK}	Crosstalk ^e
Bandwidth ^e BW $R_L = 50 \Omega$ Room 290										290	Room	_	BW	Bandwidthe
Total Harmonic Distortion THD Signal = 1 V_{RMS} , 20 Hz to 20 kHz, $R_L = 600 \Omega$ Room 0.09										0.09	Room		THD	Total Harmonic Distortion
Source Off Capacitance ^e C _{S(off)} 3.1										3.1			C _{S(off)}	Source Off Capacitance ^e
Drain Off Capacitance $C_{D(off)}$ $f = 1 \text{ MHz}$ Room 11.7										11.7	Room	f = 1 MHz		Drain Off Capacitance ^e
Channel On Capacitance ^e C _{D(on)} 16.5		1								16.5			, ,	Channel On Capacitance ^e
Power Supplies		<u> </u>											()	•
Power Supply Current I+ Room Full 0.001 0.5	0.5 1									0.001			l+	• •
Negative Supply Current 1- VIN = 0 V, 01 V+ Full -1 -1	1	- 0.5 - 1	- 1	- 1	- 1	- 1	-		- 1			V _{IN} = 0 V, or V+	l-	Negative Supply Current
		- 0.5 - 1		- 0.5 - 1						- 0.001			I _{GND}	Ground Current

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

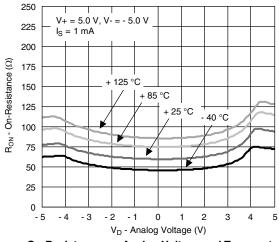
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



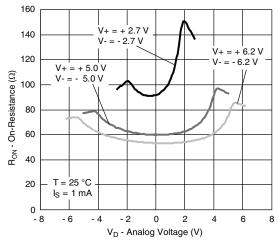
On-Resistance vs. V_D (Single Supply Voltage)



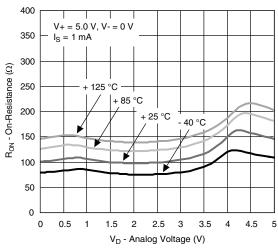
On-Resistance vs. Analog Voltage and Temperature



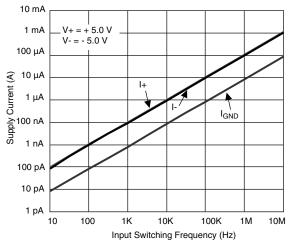
On-Resistance vs. Analog Voltage and Temperature



On-Resistance vs. V_D (Dual Supply Voltage)



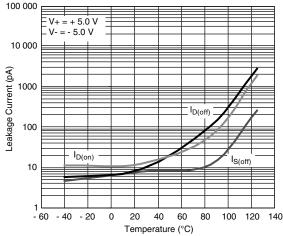
On-Resistance vs. Analog Voltage and Temperature



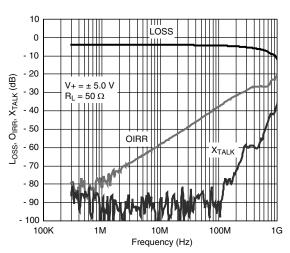
Supply Current vs. Input Switching Frequency



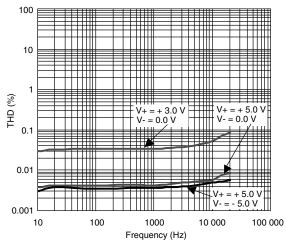
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



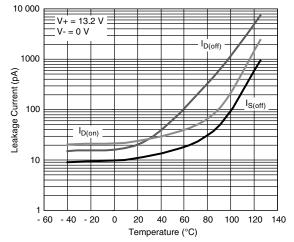
Leakage Current vs. Temperature



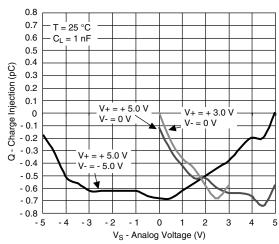
Insertion Loss, Off-Isolation, Crosstalk vs. Frequency



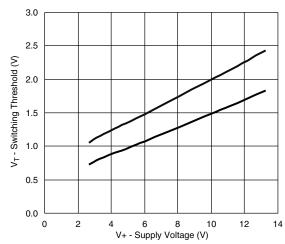
Total Harmonic Distortion vs. Frequency



Leakage Current vs. Temperature



Charge Injection vs. Analog Voltage



Switching Threshold vs. Supply Voltage

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TEST CIRCUITS

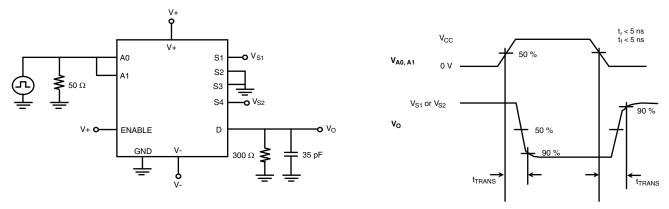


Figure 1. Transition Time

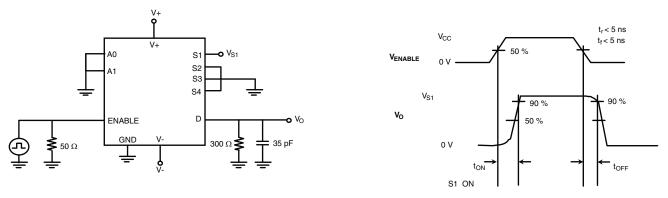


Figure 2. Enable Switching Time

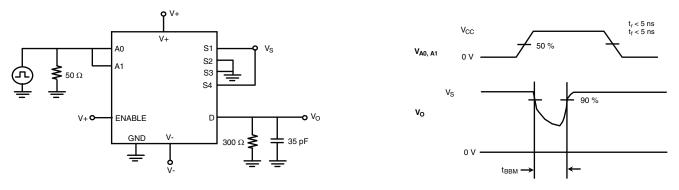


Figure 3. Break-Before-Make



TEST CIRCUITS

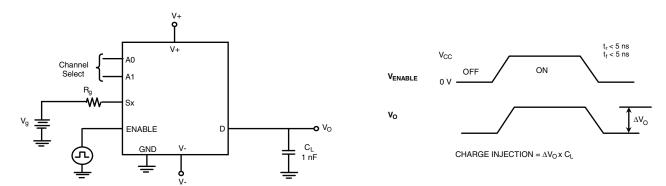


Figure 4. Charge Injection

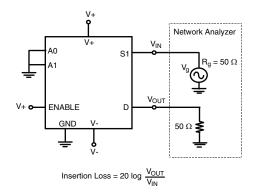


Figure 5. Insertion Loss

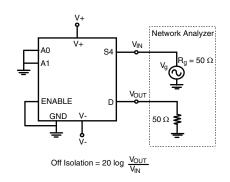


Figure 6. Off-Isolation

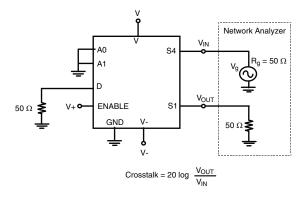


Figure 7. Crosstalk

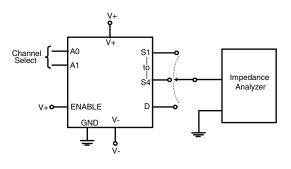


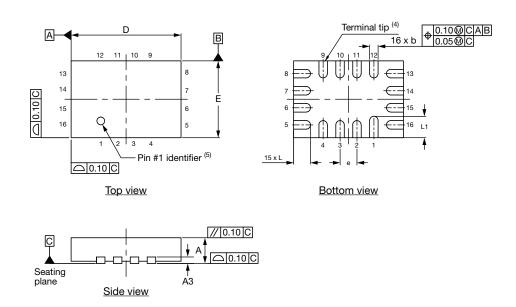
Figure 8. Source/Drain Capacitance

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Document Number: 69934 S11-1429-Rev. C, 18-Jul-11



Thin miniQFN16 Case Outline



DIMENSIONS		MILLIMETERS (1)			INCHES		
DIMENSIONS	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.50	0.55	0.60	0.020	0.022	0.024	
A1	0	-	0.05	0	-	0.002	
A3	A3 0.15 ref. 0.006 ref.						
b	0.15	0.20	0.25	0.006	0.008	0.010	
D	2.50	2.60	2.70	0.098	0.102	0.106	
е	0.40 BSC			0.016 BSC			
Е	1.70	1.80	1.90	0.067	0.071	0.075	
L	0.35	0.40	0.45	0.014	0.016	0.018	
L1	0.45	0.50	0.55	0.018	0.020	0.022	
N (3)		16			16		
Nd ⁽³⁾		4			4		
Ne ⁽³⁾		4			4		

Notes

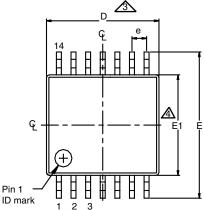
- (1) Use millimeters as the primary measurement.
- (2) Dimensioning and tolerances conform to ASME Y14.5M. 1994.
- (3) N is the number of terminals. Nd and Ne is the number of terminals in each D and E site respectively.
- (4) Dimensions b applies to plated terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.
- (5) The pin 1 identifier must be existed on the top surface of the package by using identification mark or other feature of package body.
- (6) Package warpage max. 0.05 mm.

ECN: T16-0226-Rev. B, 09-May-16

DWG: 6023



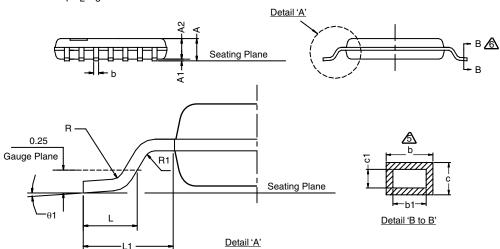
14L TSSOP



Notes:

- 1. All dimensions are in millimeters (angles in degrees)
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982
- Dimension 'D' does not include mold flash, protrusions or gate burrs

- △ Dimension 'E1' does not include internal flash or protrusion △ Dimension 'b' does not include dambar protrusion △ Cross section B to B to be determined at 0.10 mm to 0.25 mm from the lead tip



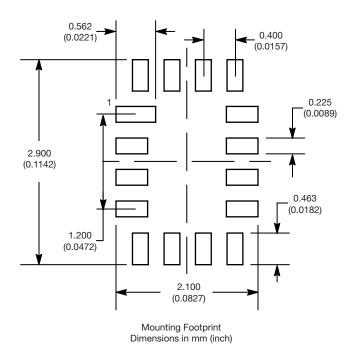
SYMBOL	MINIMUM	NOMINAL	MAXIMUM				
Α	-	-	1.20				
A1	0.05	- 0.15					
A2	0.80	0.90 1.05					
D	4.9	5.0	5.1				
E1	4.3	4.4	4.5				
Е	6.2	6.4	6.6				
L	0.45	0.60	0.75				
R	0.09	-	-				
R1	0.09	-	-				
b	0.19	-	0.30				
b1	0.19	0.22	0.25				
С	0.09	-	0.20				
c1	0.09	-	0.16				
θ1	0°	-	8°				
L1		1.0 ref.	•				
е		0.65 BSC					

DWG: 5962

Document Number: 69938 Revision: 14-Jan-08



RECOMMENDED MINIMUM PADS FOR MINI QFN 16L





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